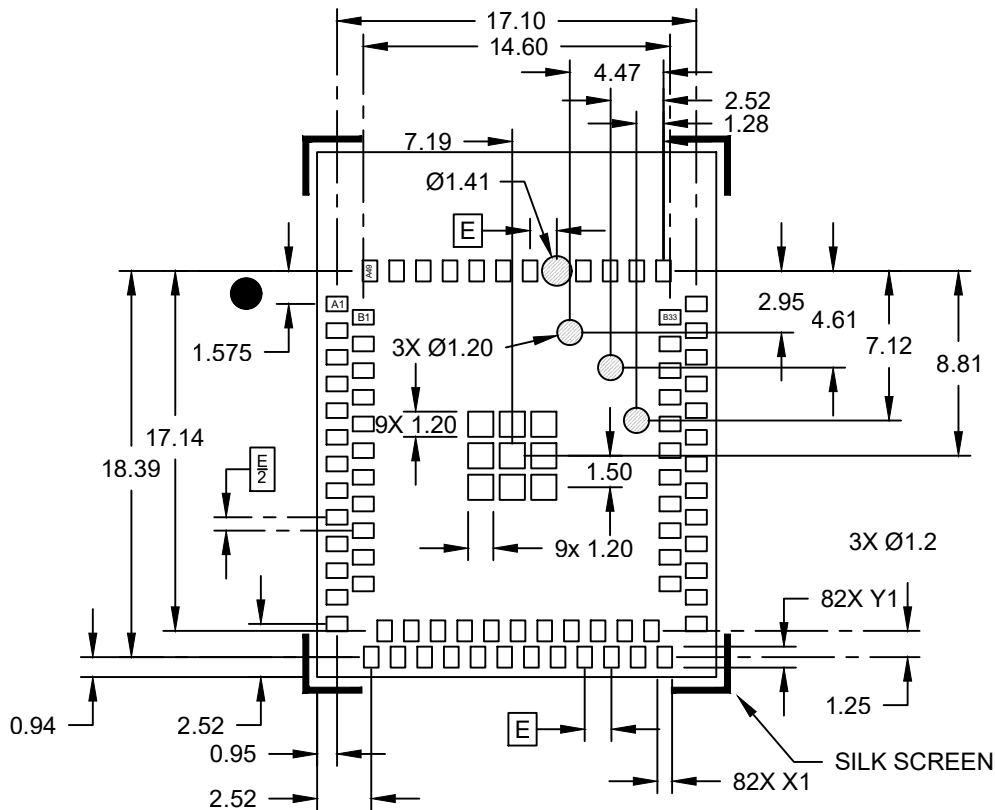


82L-PCB Module (6TW) - 19x25x2.75mm - [MODULE] with Metal Shield and Coaxial Connector

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/package3>



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension	Limits	MIN	NOM	MAX
Contact Pitch	E	1.27 BSC		
Contact Pad Width (Xnn)	X1			0.70
Contact Pad Length (Xnn)	Y1			1.00

Copper Keep-Out Area for Test Point

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M
BSC: Basic Dimension. The theoretically exact value is shown without tolerances.
2. For best soldering results, please refer to IPC-7093.